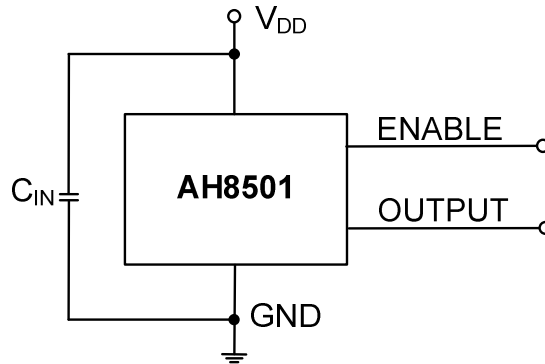


Typical Applications Circuit



Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 100nF typical and should be placed as close to the supply pin as possible.

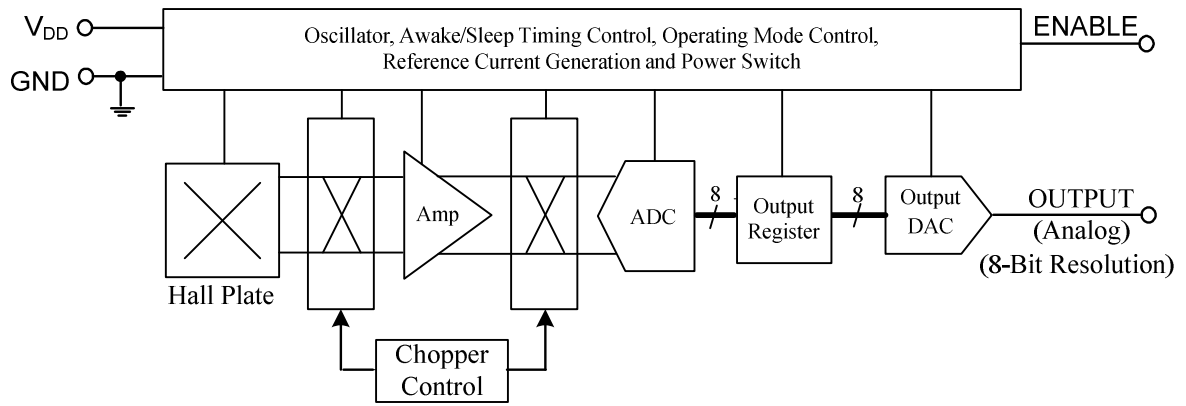
Pin Descriptions

Package: U-DFN2020-6

Pin Number	Pin Name	Function
1	OUTPUT	Output Pin
2	NC	No Connection (Note 5)
3	V_{DD}	Power Supply Input
4	ENABLE	<p>Device "Awake" and "Sleep" control pin: An external PWM signal to the ENABLE pin controls the operating modes (Sleep Mode, Auto-Run Mode and External Drive Mode), awake and sleep periods to adjust the sampling rate and to minimize the power consumption to achieve micropower operation.</p> <p>When the ENABLE = GND continuously the device is in sleep mode consuming only 8.9μA typical at 1.8V. When the ENABLE pin is left floating, the device defaults to sleep mode. The ENABLE pin is internally pulled low.</p> <p>When ENABLE = V_{DD} (or Logic High) continuously, device is in auto-run mode with sampling rate of 6.25kHz typical consuming 1.01mA at 1.8V</p> <p>In external drive mode, an external PWM signal can be used to drive the ENABLE pin to adjust the sampling frequency up to 7.14kHz typical.</p> <p>A minimum pulse width needed on ENABLE pin to start one Awake/Sleep cycle (i.e. one sample/conversion cycle) is 20μs typical. We recommended using a pulse width of 40μs minimum. The minimum awake period for one sample/conversion cycle is 140μs typical.</p>
5	GND	Ground Pin
6	NC	No Connection (Note 5)
Pad	Pad	<p>The center exposed pad – No connection internally. The exposed pad can be left open (unconnected) or tied to the GND on the PCB layout.</p>

Note: 5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

Functional Block Diagram



Absolute Maximum Ratings (Note 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V _{DD} and V _{OUT}	Supply Voltage and Output Voltage (Note 7)	4	V
V _{DD_REV} and V _{OUT_REV}	Reverse Supply and Output Voltage	-0.3	V
I _{OUT}	Output Current (limited by 10kOhms output resistor)	V _{DD} /10	mA
B	Magnetic Flux Density Withstand	Unlimited	
P _D	Package Power Dissipation	U-DFN2020-6	230 mW
T _s	Storage Temperature Range	-65 to +150	°C
T _J	Maximum Junction Temperature	150	°C
ESD HBM	Human Body Model (HMB) ESD Capability	6	kV

- Notes:
- Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
 - The absolute maximum V_{DD} of 4V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V _{DD}	Supply Voltage	Operating	1.6V to 3.6V	V
T _A	Operating Temperature Range	Operating	-40 to +85	°C

Electrical Characteristics (Notes 8 & 9) (@T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified.)

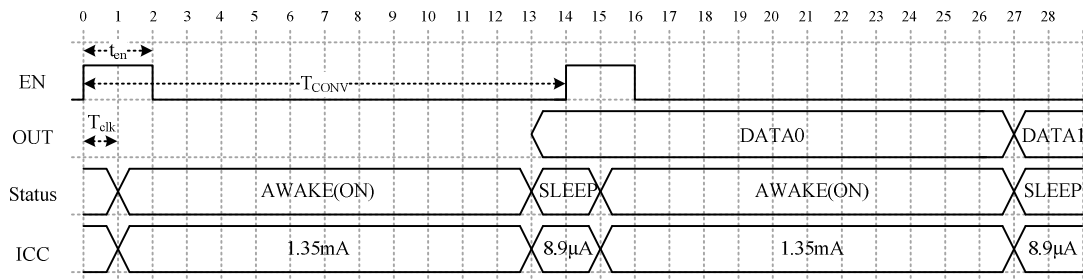
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Supply Current						
I _{DD_AWAKE}	Supply Current in Awake Period (During "Awake" Period)	V _{OUTPUT} = V _{DD} /2, ENABLE = V _{DD} , V _{DD} = 1.8V (Note 10)	-	1.35	1.7	mA
		V _{OUTPUT} = V _{DD} /2, ENABLE = V _{DD} , V _{DD} = 3V (Note 10)	-	1.92	2.4	
I _{DD_SLEEP}	Supply Current in Sleep Mode (During 'Sleep' Period)	V _{OUTPUT} = V _{DD} /2, ENABLE = GND, V _{DD} = 1.8V	-	8.93	15	µA
		V _{OUTPUT} = V _{DD} /2, ENABLE = GND, V _{DD} = 3V	-	11.1	18	
I _{DD_20Hz}	Average Supply Current at 20Hz Sample Rate	V _{OUTPUT} = V _{DD} /2, ENABLE clocking at 20Hz frequency, V _{DD} = 1.8V (Note 10)	-	12.1	20	µA
		V _{OUTPUT} = V _{DD} /2, ENABLE clocking at 20Hz frequency, V _{DD} = 3V (Note 10)	-	15.7	25	µA
I _{DD_7kHz}	Average Supply Current at 7.14kHz Sample Rate	V _{OUTPUT} = V _{DD} /2, ENABLE clocking at 7.14kHz, V _{DD} = 1.8V (Note 10)	-	1.16	1.5	mA
		V _{OUTPUT} = V _{DD} /2, ENABLE clocking at 7.14kHz, V _{DD} = 3V (Note 10)	-	1.65	2.1	mA
I _{DD_AUTORUN}	Average Supply Current in Auto-Run Mode when ENABLE = Logic High (or V _{DD}) Continuously (The sampling frequency when ENABLE = High continuously is 6.25kHz)	V _{OUTPUT} = V _{DD} /2, ENABLE = V _{DD} , V _{DD} = 1.8V (Note 10)	-	1.01	1.3	mA
		V _{OUTPUT} = V _{DD} /2, ENABLE = V _{DD} , V _{DD} = 3V (Note 10)	-	1.44	1.8	mA

- Notes:
- When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guarantee the output sampling. After the supply voltage reaches minimum operating voltage, the output state is valid after 140µs after the ENABLE pin pulled or clocked high.
 - Typical data is at T_A = +25°C, V_{DD} = 1.8V unless otherwise stated.
 - The parameters are not tested in production, they are guaranteed by design, characterization and process control.

Electrical Characteristics (cont) (@T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified.)

ENABLE Pin Timing, Conversion Rate and I_{DD} Supply Current Relationship

AH8501 ENABLE Pin Clocked

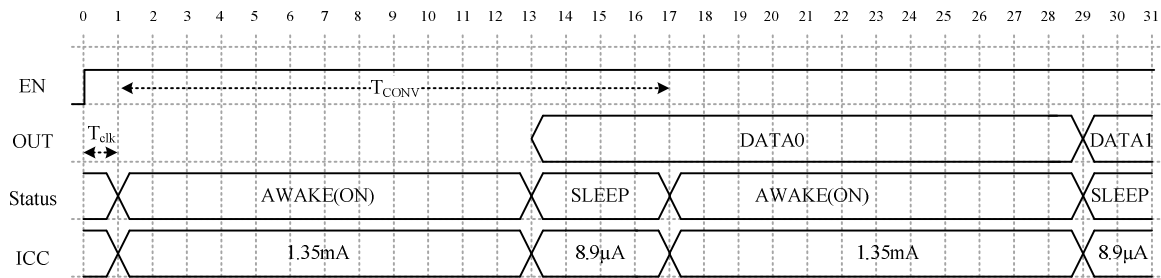


Status: **AWAKE**: chip processing phase (12*T_{clk}), **SLEEP**: chip retain data

T_{clk}: internal clock period, typical = 10µs
 t_{en}: pulse width of enable signal, minimum=2*T_{clk}= 20µs (typical)
 T_{CONV}: One sample/conversion cycle = 14*T_{clk}= 140µs (typical)

I_{DD}(@ V_{DD} = 1.8V, 25°C):
 (1) If ENABLE pin clocked at maximum (~7.14 kHz): I_{DD} = 1.35mA*12/14+8.93µA*2/14 ≈ 1.16mA
 (2) If ENABLE pin clocked at 20Hz: I_{DD} ≈ 12µA
 (3) If ENABLE clocking period=T, I_{DD} = 1.35mA*120µs/T + 8.93µA*(T-120µs)/T

AH8501 ENABLE = Logic High (V_{DD}) Continuously – Auto-Run Mode



T_{clk}: internal clock period, typical= 10µs
 T_{CONV}: One sample/conversion period when ENABLE = High (V_{DD}) = 16*T_{clk}=160 µs

I_{DD}(@ V_{DD} = 1.8V, 25°C):
 I_{DD} = 1.35mA*120µs/160µs + 8.93µA*40µs/160µs ≈ 1.01mA (typical)

Electrical Characteristics (cont.) (Notes 11, 12 & 13) (@ $T_A = +25^\circ\text{C}$, $V_{DD} = 1.8\text{V}$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$t_{ON_INITIAL}$	Initial Power On Time	$V_{DD} = 1.8\text{V}$, $T_A = +25^\circ\text{C}$, $C_{IN}=0.1\mu\text{F}$, V_{DD} rise time =10us, (Note 14)	-	1	-	ms
		$V_{DD} = 3\text{V}$, $T_A = +25^\circ\text{C}$, $C_{IN}=0.1\mu\text{F}$, V_{DD} rise time =10us, (Note 14)	-	0.2	-	ms
t_{en}	Minimum Pulse Width on ENABLE Pin To Start One Conversion Cycle When Driving ENABLE pin Externally (See application note section)	$V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (Note 14)	-	20	-	μs
T_{CONV}	Minimum Period of One Sample/Conversion Cycle	$V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (Note 14)	100	140	200	μs
f_{MAX}	Maximum Sampling Frequency	$V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, (Note 14)	-	7.14	-	kHz
f_{EN_HIGH}	Sampling Frequency when ENABLE = Logic High (or V_{DD}) continuously.	ENABLE = High (V_{DD}), $V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (Note 14)	-	6.25	-	kHz
V_{EN_LOW}	Enable pin input low voltage	$V_{DD} = 1.8\text{V}$ (Note 13)	0.4	0.5	0.6	V
		$V_{DD} = 3.0\text{V}$ (Note 13)	0.8	0.9	1	V
V_{EN_HIGH}	Enable pin input high voltage	$V_{DD} = 1.8\text{V}$ (Note 13)	1.2	1.3	1.4	V
		$V_{DD} = 3\text{V}$ (Note 13)	2.2	2.3	2.4	V
Output Characteristics						
R_{OUT}	DC Output Resistance	ENABLE = V_{DD} or GND, $V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, (Note 14)	-	10	13	$\text{k}\Omega$
Noise_RMS	Input Referred Noise, RMS (Note 14)	$C_{IN} = \text{Open}$, $V_{DD} = 1.8\text{V}$, $T_A = +25^\circ\text{C}$,	-	0.36	-	G
		$C_{IN} = \text{Open}$, $V_{DD} = 3.0\text{V}$, $T_A = +25^\circ\text{C}$,	-	0.24	-	G
ADCRES DACRES	Internal ADC and DAC resolution	(Note 14)	-	8	-	Bit
V_{OUT_RES}	Output Voltage Resolution	$V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	-	$V_{DD}/256$	-	mV
V_{OUTH}	Max. Output Voltage	$V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	-	$V_{DD} \cdot 255/256$	-	V
V_{OUTL}	Min. Output Voltage	$V_{DD} = 1.6\text{V}$ to 3.6V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$	-	0	-	V

- Notes:
- When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guarantee the output sampling. The output state is valid after $t_{ON_INITIAL}$ from the supply voltage reaching the minimum operating voltage.
 - Typical data is at $T_A = +25^\circ\text{C}$, $V_{DD} = 1.8\text{V}$ unless otherwise stated.
 - Maximum and minimum parameters values over operating temperature range are not tested in production, they are guaranteed by design, characterization and process control.
 - The parameter is not tested in production, they are guaranteed by design, characterization and process control.

Electrical Characteristics (cont.) (Notes 11, 12 & 13) (@T_A = +25°C, V_{DD} = 1.8V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Magnetic Characteristics						
B _{RANGE}	Measurable Magnetic Flux Density Range	V _{DD} = 1.8V, T _A = +25°C	±388	±400	±412	G
		V _{DD} = 3V, T _A = +25°C	±382	±395	±408	G
G _{RES}	Gauss Resolution	V _{DD} = 1.8V, T _A = +25°C	3.033	3.125	3.221	G/LSB
		V _{DD} = 3V, T _A = +25°C	2.994	3.084	3.179	G/LSB
V _{NULL}	Quiescent Output Voltage with zero gauss	B = 0.5G, T _A = +25°C	-	V _{DD} / 2	-	V
		V _{DD} = 1.8V, T _A = +25°C	0.882	0.9	0.918	V
		V _{DD} = 3V, T _A = +25°C	1.47	1.5	1.53	V
V _{OFFSET}	Quiescent Output Voltage Offset	B = 0.5G, V _{DD} = 1.8V, T _A = +25°C	-1%	-	1%	% of V _{DD}
		B = 0.5G, V _{DD} = 3V, T _A = +25°C	-1%	-	1%	% of V _{DD}
		B = 0.5G, V _{DD} = 1.6V to 3.6V, T _A = -40°C to +85°C (Note 14)	-1.5	-	1.5	% of V _{DD}
V _{SENS}	Output Voltage Sensitivity	V _{DD} = 1.8V, T _A = +25°C	2.183	2.25	2.318	mV/G
		V _{DD} = 3V, T _A = +25°C	3.686	3.80	3.914	
V _{SENS_ACC}	Sensitivity Accuracy	V _{DD} = 1.8V, T _A = +25°C	-3	-	3	%
		V _{DD} = 3V, T _A = +25°C	-3	-	3	%
		V _{DD} = fixed at any one voltage between 1.6V to 3.6V, T _A = -40°C to +85°C (Note 14, Note 15)	-6	-	6	%
TC_ERR _{SENS}	Sensitivity error over full temperature	V _{DD} =fixed, T _A = -40°C to +85°C, (Note 14)	-3	-	3	%
Lin+	Positive linearity (span linearity)	V _{DD} = 1.8V, T _A = +25°C (Note 14)	-	99.9	-	%
		V _{DD} = 3.0V, T _A = +25°C (Note 14)	-	99.7	-	%
Lin-	Negative linearity (span linearity)	V _{DD} = 1.8V, T _A = +25°C (Note 14)	-	100.1	-	%
		V _{DD} = 3.0V, T _A = +25°C (Note 14)	-	100.4	-	%

- Notes:
- When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guarantee the output sampling. The output state is valid after t_{ON_INITIAL} from supply voltage reaching the minimum operating voltage.
 - Typical data is at T_A = +25°C, V_{DD} = 1.8V unless otherwise stated.
 - Maximum and minimum parameters values over operating temperature range are not tested in production, they are guaranteed by design, characterization and process control.
 - The parameter is not tested in production, they are guaranteed by design, characterization and process control.
 - This term constitutes of output voltage sensitivity temperature coefficient error and sensitivity trim accuracy.

Application Note

ENABLE Pin - Awake and Sleep Period Control

ENABLE pin controls the device's "Awake" and "Sleep" periods and operating modes (Sleep, Auto-Run and External Drive modes).

When the ENABLE pin is pulled low (ENABLE = GND) continuously, the device enters sleep mode where the supply current is 8.93µA typical at V_{DD} = 1.8V (the output is 0.9V). The ENABLE pin is internally pulled low and therefore the default mode is the sleep mode if the ENABLE pin is left floating.

When the ENABLE pin is pulled high (ENABLE = V_{DD} or pulled high) the device enters auto-run mode with the conversion time T_{CONV} of 16 clock cycles (160µs typical) and therefore the sampling rate is 6.25kHz. The average supply current with the ENABLE pin pulled high continuously is 1.01mA at V_{DD} = 1.8V.

In external drive mode, the sample rate can be controlled between 0 to 7.14kHz by clocking the ENABLE pin with an external PWM signal. The minimum pulse width needed on the ENABLE pin to start sample/conversion is 20µs typical; we recommend using pulse width of 40µs minimum.

When the ENABLE pin is clocked, the conversion time (signal acquisition, conversion and output update) T_{CONV} is 14 clock cycles (140µs typical). When the ENABLE goes high, the sample trigger delay is 1 clock pulse (10µs) where supply current remains at 8.93µA typical at V_{DD} = 1.8V. After the sample trigger delay, the next 12 clock pulse (120µs typical) is 'Awake' period where the typical supply current is 1.35mA at 1.8V supply. The next pulse (10µs) is used to update the output stage and during this time the supply current drops back to 8.93µA typical at 1.8V supply. Therefore, the average supply current while the device is at the maximum sampling rate of 7.14kHz is 1.16mA typical at 1.8V supply. At a sampling rate of 20Hz, the supply current is 12µA typical at V_{DD} = 1.8V achieving micropower operation.

For ENABLE pin clocking period of T, the average current is given by

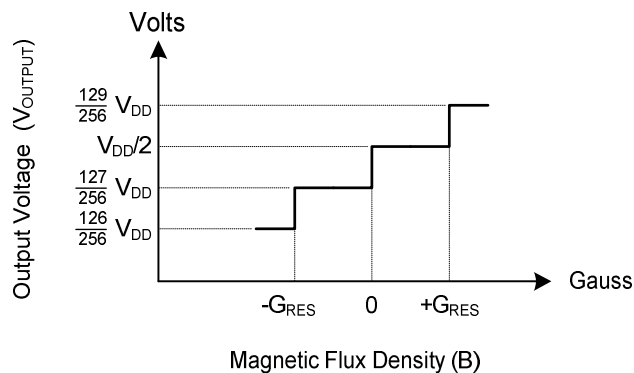
$$I_{DD} = \frac{1.35mA \times 120\mu s + 8.93\mu A \times (T - 120\mu s)}{T} \quad (@ 1.8V)$$

$$I_{DD} = \frac{I_{DD_AWAKE} \times 120\mu s + I_{DD_SLEEP} \times (T - 120\mu s)}{T} \quad (\text{General equation})$$

Quiescent Output Voltage V_{NULL} and Offset Voltage

The figure below shows the ideal transfer curve near zero magnetic field (B = 0Gauss). Zero Gauss is the transition point between V_{OUTPUT} = V_{DD}*127/128 and V_{OUTPUT} = V_{DD}/2. When B is slightly larger than zero, the output is one-half the supply voltage typically.

Quiescent output voltage (V_{NULL}) is defined as the typical output voltage when B = 0.5Gauss (slightly higher than 0G). Any difference of V_{NULL} from V_{DD}/2 introduces offset (V_{OFFSET}).



Transfer Curve Near 0 Gauss

Application Note (continued)

Sensitivity and Transfer Characteristic

The device responds to the magnetic flux density perpendicular to the part marking surface. For South pole magnetic flux density increase from 0G, the output voltage will increase from V_{NULL} and for a North magnetic pole field, the output will decrease from V_{NULL} . The changes in the voltage level up or down are symmetrical to V_{NULL} and are proportional to the magnetic flux density.

The output voltage change is proportional to the magnitude and polarity of the magnetic field perpendicular to the part marking surface. This proportionality is defined as output voltage sensitivity and is given by

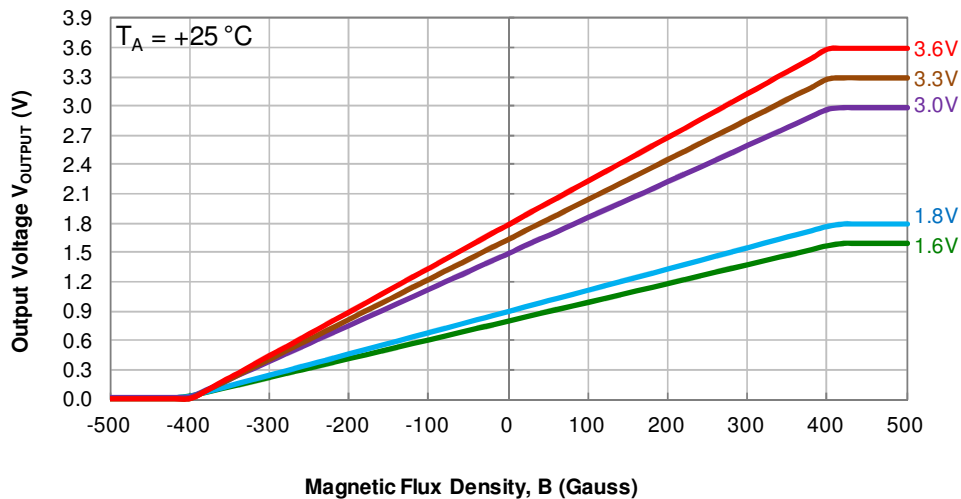
$$V_{SENS} = \frac{(V_{OUT(B,MAX)} - V_{OUT(B,MIN)})}{(B_{MAX} - B_{MIN})}$$

The AH8501 has a measurable magnetic field range of +/-400G and output voltage range of 0V to (255/256) V_{DD} . Therefore sensitivity at 1.8V is given by

$$V_{SENS_{1.8V}} = \frac{1.8V}{800G} = 2.25mV/G$$

The device has an internal ADC and DAC with a resolution of 8-bits. Therefore, the measurement resolution is 3.125G/LSB at $V_{DD} = 1.8V$. In terms of voltage, the output resolution at 1.8V is 7mV/LSB typical. The device follows the 8-bit step for transfer curve superimposed on the V_{SENS} above. This difference in theoretical linear value with 8-bit resolution steps produces a measurement (quantization) error at each step.

$$\begin{aligned} \text{Quantization error (also measurement error)} &= 0.5 * \text{step} = V_{DD}/512(\text{output voltage}), \text{ OR} \\ &= \text{Full magnetic range}/512 (\text{input magnetic field}) \end{aligned}$$



Transfer Curve – Output Voltage vs. Magnetic Flux Density

Application Note (cont.)

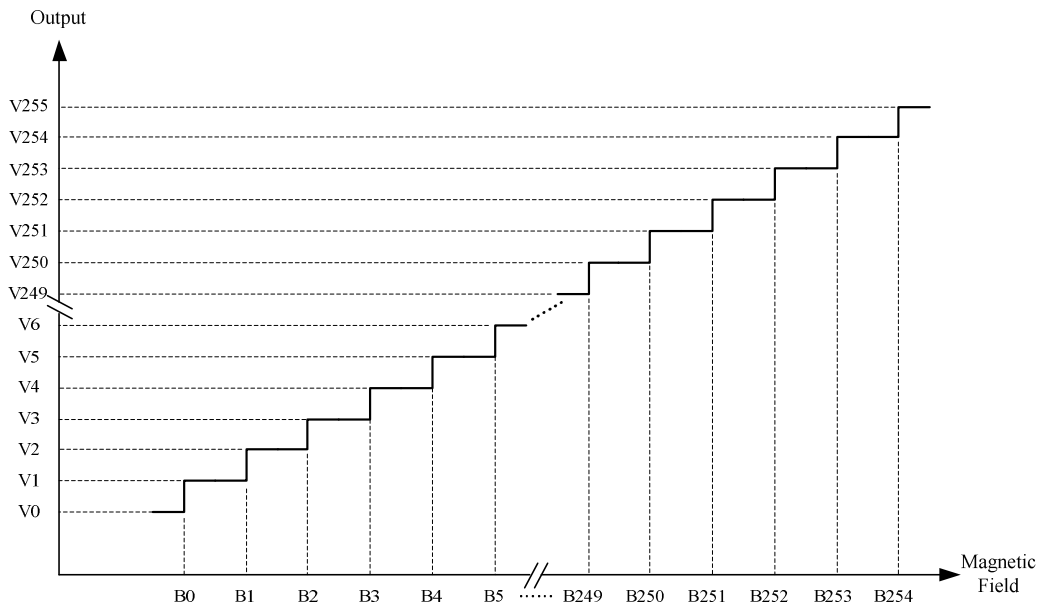
Span Linearity

The coordinate of transition points (V0~V255 and B0~B254) can be extracted from a transfer curve. Span linearity is defined and based on these coordinate points.

Span linearity is defined as linearity arising from sensitivity differences between the maximum flux density range and half of the range for positive and negative flux density. Referring to the diagram below, north field span linearity LIN- and south field span linearity LIN+ are given by

$$LIN- = \frac{(V0 - V127)/(B0 - B127)}{(V64 - V127)/(B64 - B127)}$$

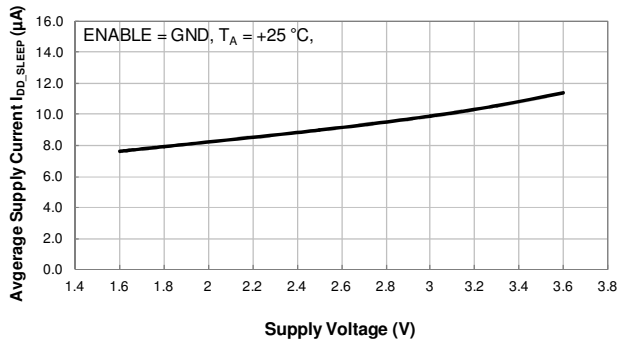
$$LIN+ = \frac{(V254 - V127)/(B254 - B127)}{(V190 - V127)/(B190 - B127)}$$



Typical Operating Characteristics

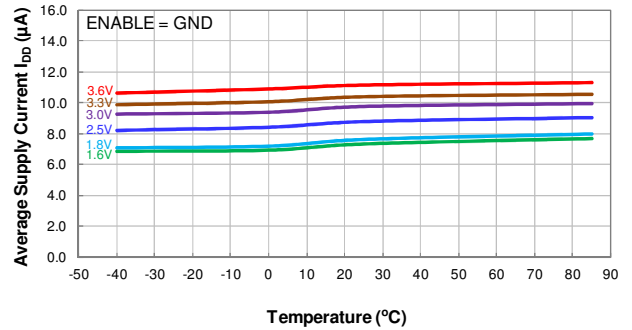
Average Supply Current

Sleep Mode



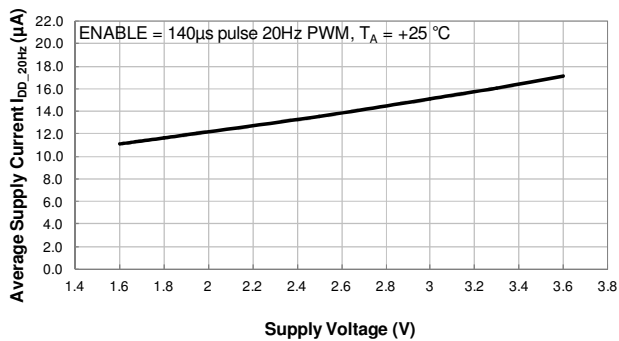
Average Supply Current (ENABLE = GND) vs Supply Voltage

Sleep Mode



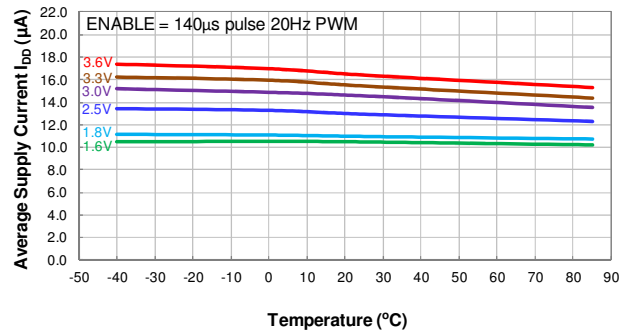
Average Supply Current (ENABLE = GND) vs Temperature

External Drive Mode - 20Hz Sample Rate



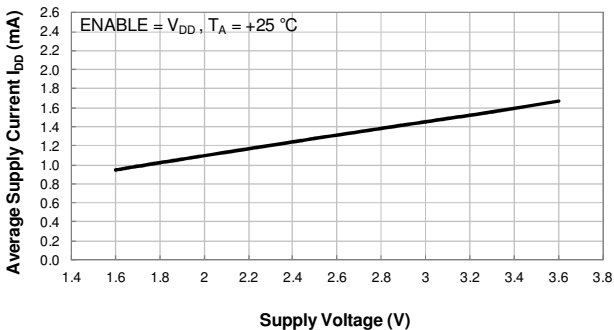
Average Supply Current (ENABLE = PWM) vs Supply Voltage

External Drive Mode - 20Hz Sample Rate



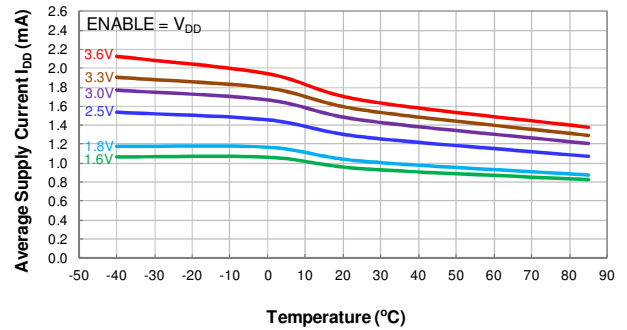
Average Supply Current (ENABLE = PWM) vs Temperature

Auto-Run Mode - 6.25kHz Sampling Rate



Average Supply Current (ENABLE = V_{DD}) vs Supply Voltage

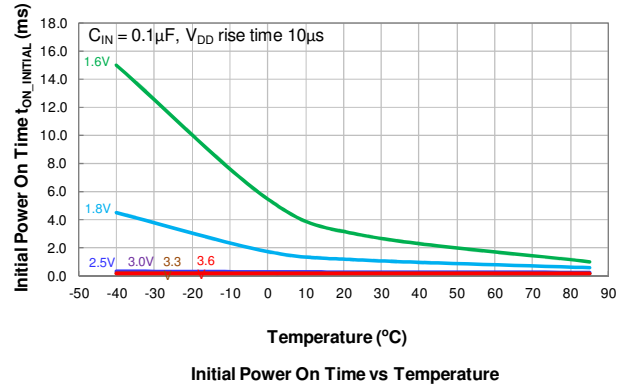
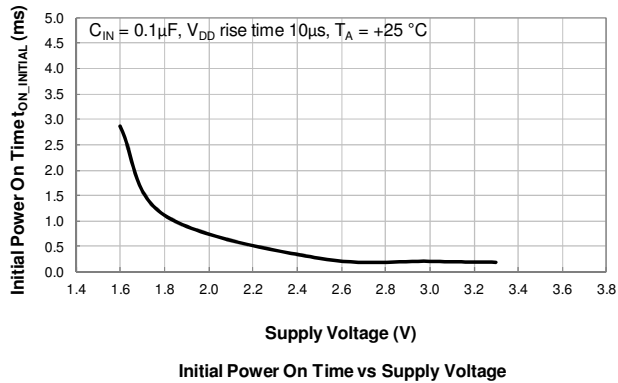
Auto-Run Mode Mode - 6.25kHz Sample Rate



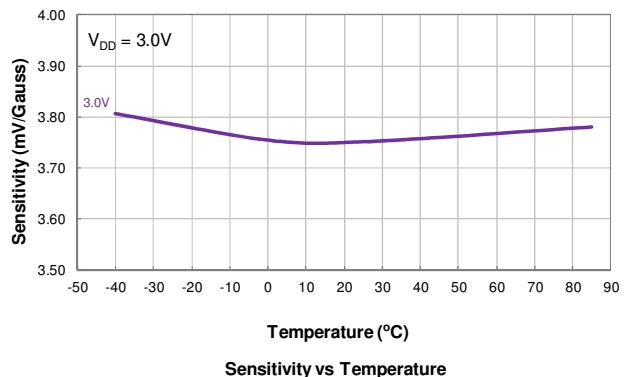
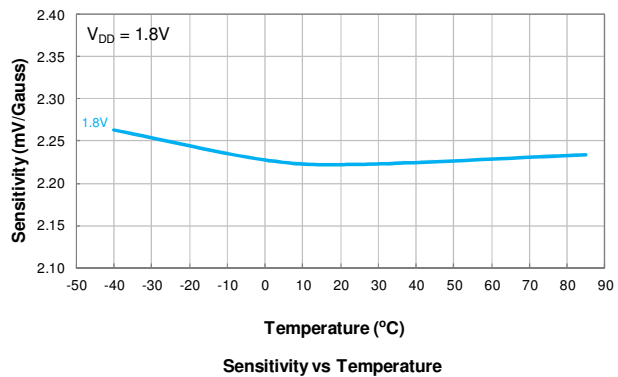
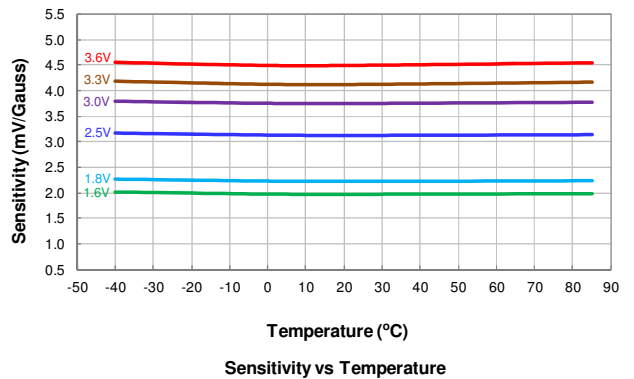
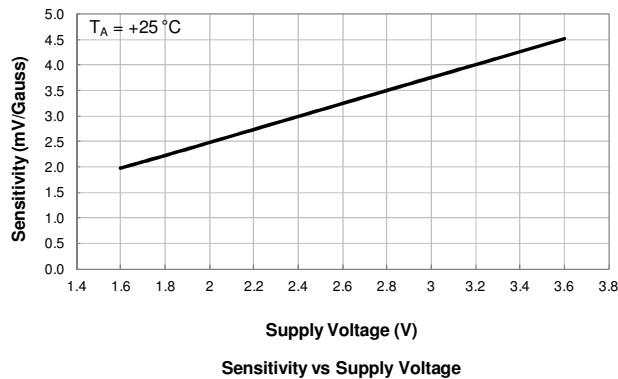
Average Supply Current (ENABLE = V_{DD}) vs Temperature

Typical Operating Characteristics (continued)

Typical Initial Power On Time

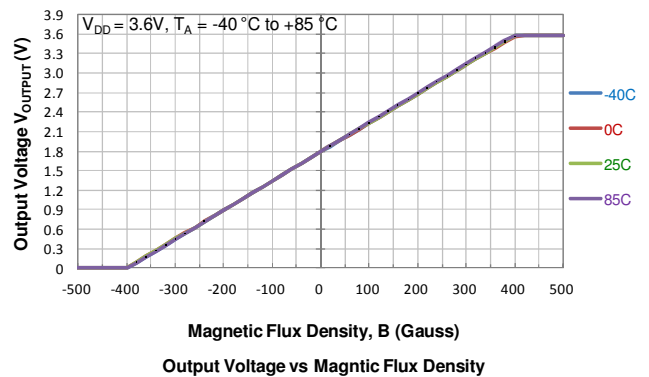
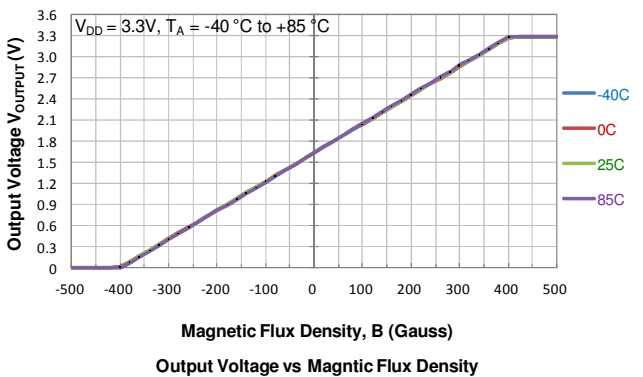
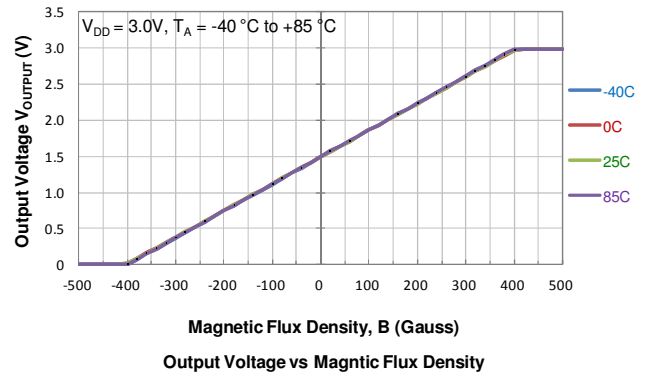
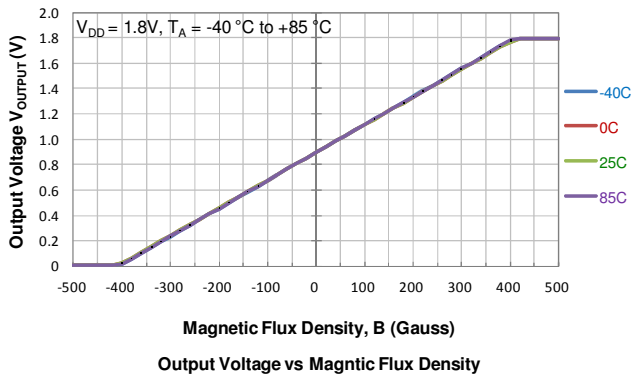
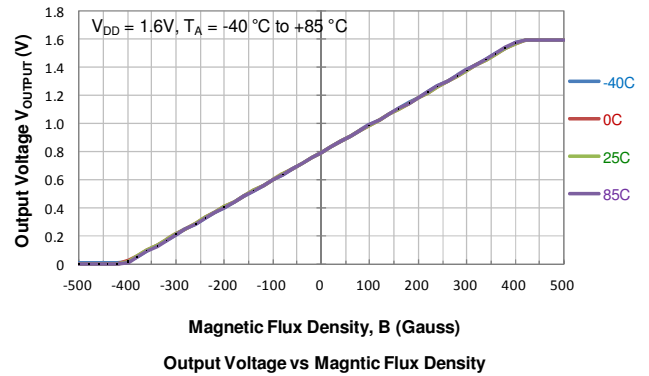
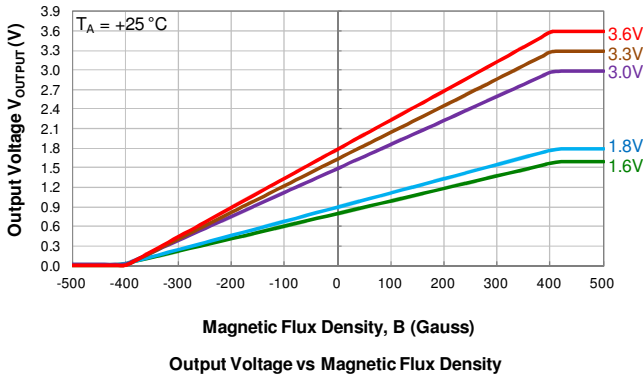


Typical Sensitivity



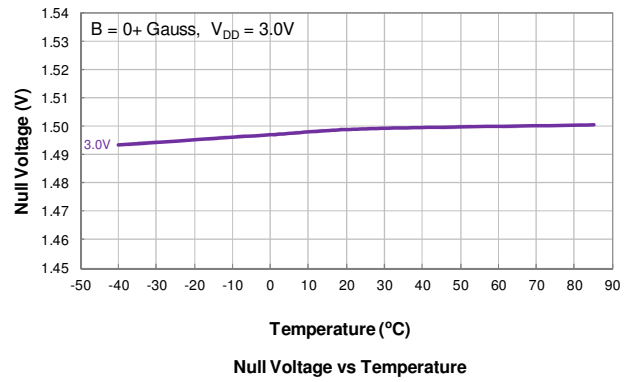
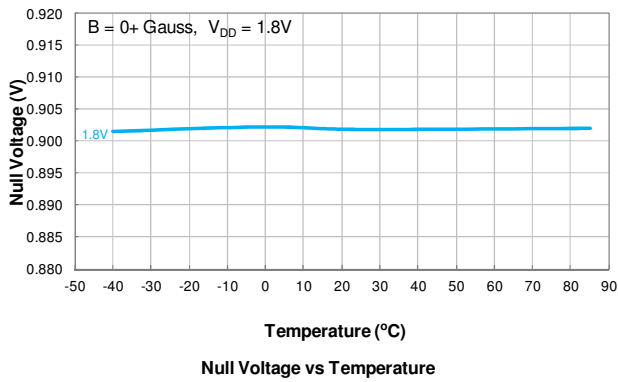
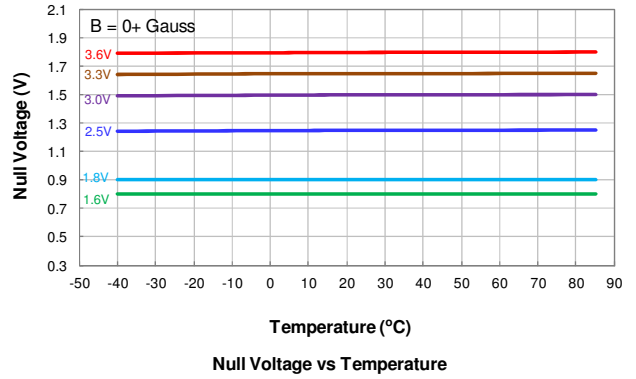
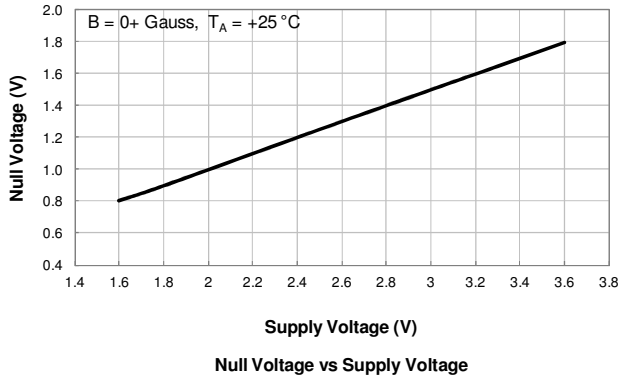
Typical Operating Characteristics (cont.)

Typical Transfer Curves



Typical Operating Characteristics (cont.)

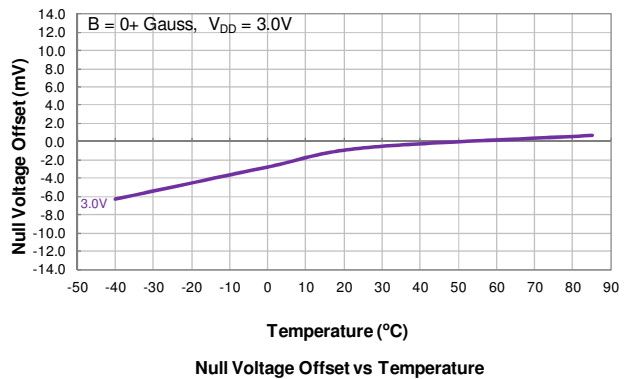
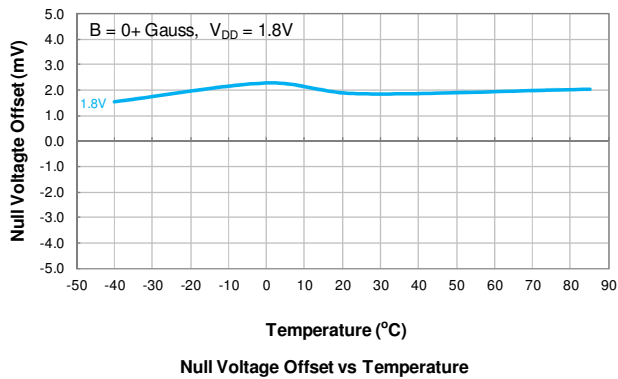
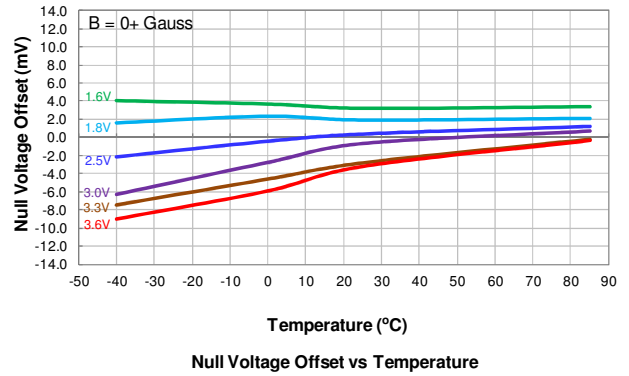
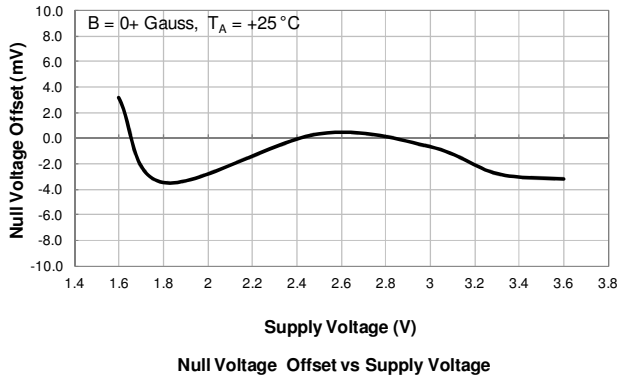
Typical Null Voltage: Output Voltage at B = 0+ Gauss (Note 16)



Note: 16. Null voltage is the voltage with magnetic flux density B = 0G at the sensor. B = 0G is also the transition point at $V_{DD} \cdot 127/128$ for internal ADC and DAC. To avoid the transition point fluctuation during measurement of null voltage, B = 0+ Gauss (e.g. 0.5G which is smaller than the 1LSB gauss step of 3.125G) is used. See definition of the null voltage in application section.

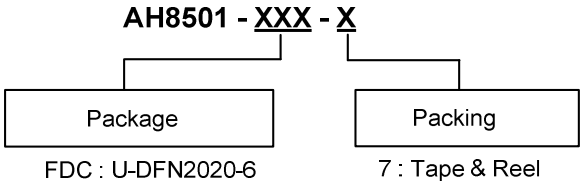
Typical Operating Characteristics (cont.)

Typical Null Voltage Offset: (Output Voltage - $V_{DD}/2$) at $B = 0+$ Gauss (Note 16)



Note: 16. Null voltage is the voltage with magnetic flux density $B = 0$ G at the sensor. $B = 0$ G is also the transition point at $V_{DD} \cdot 127/128$ for internal ADC and DAC. To avoid the transition point fluctuation during measurement of null voltage, $B = 0+$ Gauss (e.g. 0.5G which is smaller than the 1LSB gauss step of 3.125G) is used. See definition of the null voltage in application section.

Ordering Information

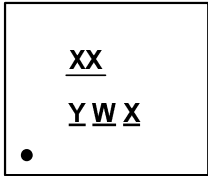


Part Number	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
AH8501-FDC-7	FDC	U-DFN2020-6	3,000/Tape & Reel	-7

Marking Information

(1) Package Type: U-DFN2020-6

(Top View)



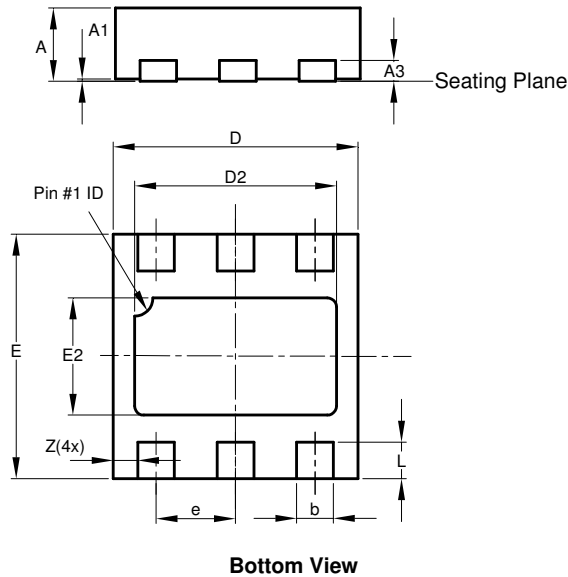
XX : Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week
X : Internal Code

Part Number	Package	Identification Code
AH8501-FDC-7	U-DFN2020-6	KR

Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

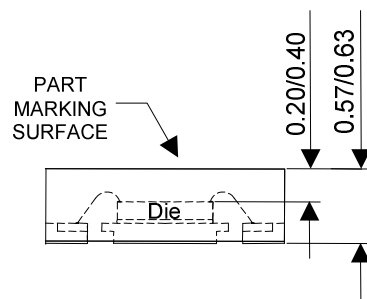
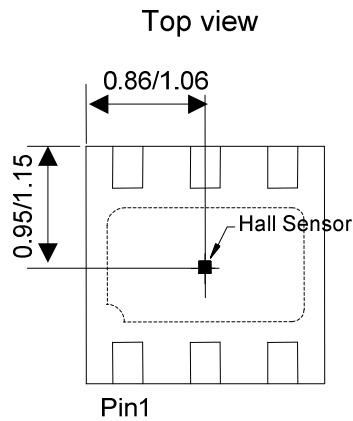
(1) Package Type: U-DFN2020-6



U-DFN2020-6 Type C			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0.00	0.05	0.02
A3	-	-	0.15
b	0.25	0.35	0.30
D	1.95	2.075	2.00
D2	1.55	1.75	1.65
E	1.95	2.075	2.0
E2	0.86	1.06	0.96
e	-	-	0.65
L	0.25	0.35	0.30
Z	-	-	0.20
All Dimensions in mm			

Bottom View

Min/Max (in mm)

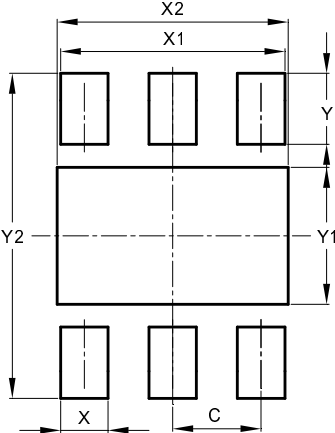


Sensor Location (TBD)

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

(1) Package Type: U-DFN2020-6



Dimensions	Value (in mm)
C	0.650
X	0.350
X1	1.650
X2	1.700
Y	0.525
Y1	1.010
Y2	2.400

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